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Signed: Stephen E. Baldwin Date: March 8, 2001
Stephen E. Baldwin, Reg. No. 27,769

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Lu et al
977,400

Serial No.: 08/977,407

Filed : November 24, 1997

For: ELECTRONIC SURFACE MOUNT
PACKAGE

Examiner: Mai, A.

Group Art Unit: 2832

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Response to Office Action

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

This Response to Office Action is being submitted in response to the Office Action of September 8, 2000.

AMENDMENTS

IN THE CLAIMS:

1. An electronic surface mount package for mounting onto the surface of a printed circuit board comprising:
- a one piece construction package having end walls, a side wall and an open bottom,